

### MD2009DFX

High voltage NPN Power transistor for standard definition CRT display

#### **General features**

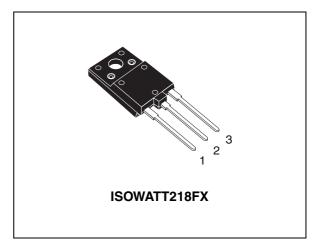
- State-of-the-art technology:
  - diffused collector "enhanced generation"
- More stable performance versus operating temperature variation
- Low base drive requirement
- Tighter h<sub>FE</sub> range at operating collector current
- Fully insulated power package U.L. compliant
- Integrated free wheeling diode
- In compliance with the 2002/93/EC European directive

### **Applications**

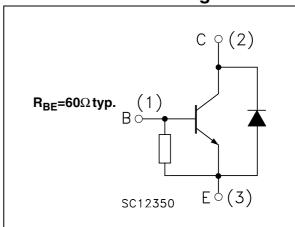
■ Horizontal deflection output for TV

### **Description**

The MD2009DFX is manufactured using Diffused Collector in Planar Technology adopting new and enhanced high voltage structure. The new MD product series show improved silicon efficiency bringing updated performance to the Horizontal Deflection stage.



### Internal schematic diagram



#### **Order codes**

| Part number | Marking   | Package      | Packaging |
|-------------|-----------|--------------|-----------|
| MD2009DFX   | MD2009DFX | ISOWATT218FX | Tube      |

Electrical ratings MD2009DFX

# 1 Electrical ratings

Table 1. Absolute maximum ratings

| Symbol            | Parameter  | Value                    | Unit |
|-------------------|--|--------------------------|------|
| V <sub>CES</sub>  | Collector-emitter voltage (V <sub>BE</sub> = 0)                              | 1500                     | ٧    |
| V <sub>CEO</sub>  | Collector-emitter voltage (I <sub>B</sub> = 0)                               | 700                      | V    |
| V <sub>EBO</sub>  | Base-emitter voltage (I <sub>C</sub> = 0)                                    | 7                        | ٧    |
| I <sub>C</sub>    | Collector current  | 10                       | Α    |
| I <sub>CM</sub>   | Collector peak current (t <sub>P</sub> < 5ms)                                | 16                       | Α    |
| I <sub>B</sub>    | Base current   | 6                        | Α    |
| P <sub>TOT</sub>  | Total dissipation at T <sub>c</sub> = 25°C                                   | 58                       | W    |
| V <sub>isol</sub> | Insulation withstand voltage (RMS) from all three leads to external heatsink |                          | ٧    |
| T <sub>stg</sub>  | Storage temperature  | e temperature -65 to 150 |      |
| TJ                | Max. operating junction temperature  | 150                      |      |

Table 2. Thermal data

| Symbol                | Parameter                            | Value | Unit |
|-----------------------|--------------------------------------|-------|------|
| R <sub>thj-case</sub> | Thermal resistance junction-case max | 2.15  | °C/W |

## 2 Electrical characteristics

(Tcase =25°C unless otherwise specified)

Table 3. Electrical characteristics

| Symbol                              | Parameter   | Test conditions  | Min. | Тур.       | Max.     | Unit     |
|-------------------------------------|---|--|------|------------|----------|----------|
| I <sub>CES</sub>                    | Collector cut-off current (V <sub>BE</sub> = 0)           | V <sub>CE</sub> = 1500V<br>V <sub>CE</sub> = 1500V, T <sub>c</sub> = 125°C   |      |            | 0.2<br>2 | mA<br>mA |
| I <sub>EBO</sub>                    | Emitter Cut-off Current (I <sub>C</sub> = 0)              | V <sub>EB</sub> = 5V   | 40   |            | 120      | mA       |
| V <sub>(BR)EBO</sub>                | Emitter-base<br>breakdown voltage<br>(I <sub>C</sub> = 0) | I <sub>E</sub> = 700mA   | 10   |            |          | V        |
| V <sub>CE(sat)</sub> <sup>(1)</sup> | Collector-emitter saturation voltage                      | $I_C = 5.5A$ , $I_B = 1.4A$  |      |            | 2.8      | V        |
| V <sub>BE(sat)</sub> <sup>(1)</sup> | Base-emitter saturation voltage                           | $I_C = 5.5A$ , $I_B = 1.4A$  |      |            | 1.3      | V        |
| h <sub>FE</sub> <sup>(1)</sup>      | DC current gain   | $\begin{split} I_{C} &= 1 \text{A}, & V_{CE} &= 5 \text{V} \\ I_{C} &= 5.5 \text{A}, & V_{CE} &= 1 \text{V} \\ I_{C} &= 5.5 \text{A} , & V_{CE} &= 5 \text{V} \end{split}$ | 4.5  | 18<br>4.7  | 7.5      |          |
| V <sub>f</sub>                      | Diode forward voltage                                     | I <sub>F</sub> = 5.5 A   |      |            | 1.6      | V        |
| t <sub>s</sub>                      | Inductive load<br>Storage time<br>Fall time               | $I_C = 5A$ , $f_h = 16KHz$<br>$I_{B(on)} = 1.5A$ , $V_{BE(off)} = -2.7V$<br>$L_{BB(off)} = 6.2\mu H$   |      | 4.5<br>0.3 | 6<br>0.6 | μs<br>μs |

<sup>1.</sup> Pulsed duration = 300 ms, duty cycle ≤ .5%.

Electrical characteristics MD2009DFX

### 2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Derating curve

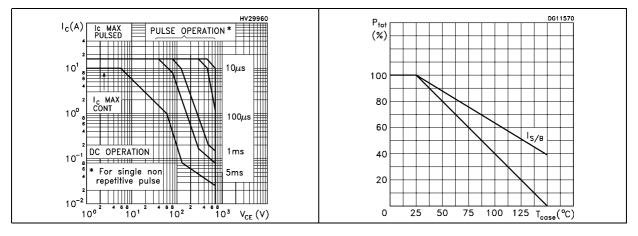


Figure 3. Output characterisics

Figure 4. Reverse biased SOA

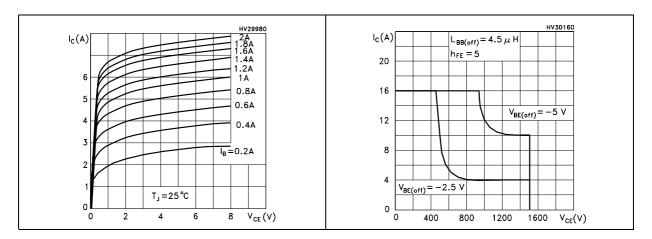


Figure 5. DC current gain

Figure 6. DC current gain

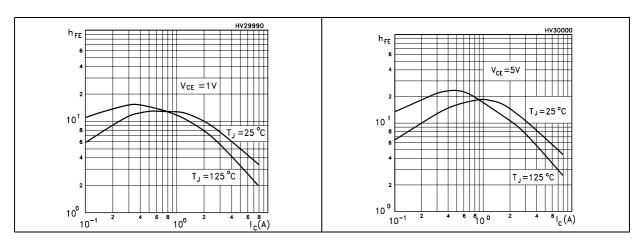


Figure 7. Collector-emitter saturation volatge Figure 8. Base-emitter saturation voltage

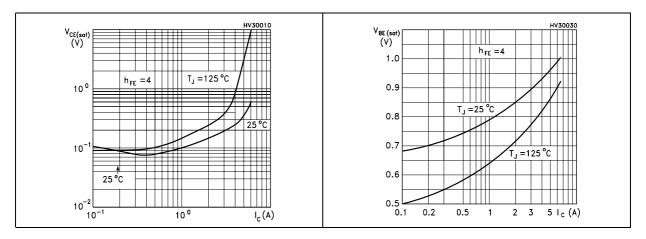
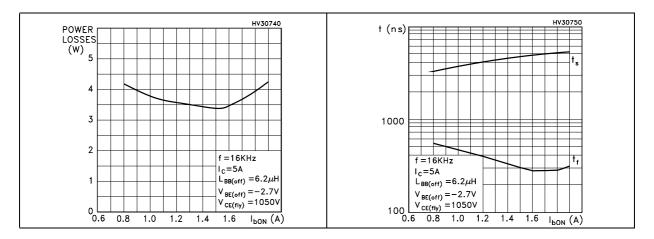


Figure 9. Power losses

Figure 10. Inductive load switching time



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Test circuits MD2009DFX

# 3 Test circuits

Figure 11. Power losses and inductive load switching test circuit

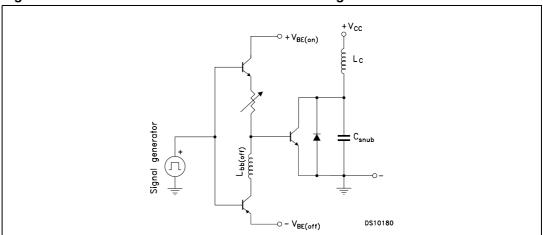
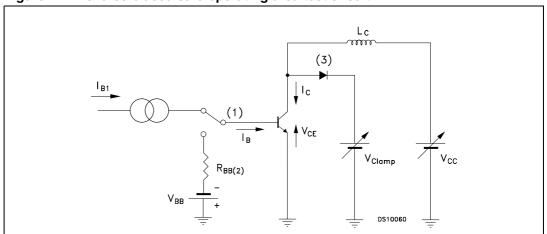


Figure 12. Reverse biased safe operating area test circuit



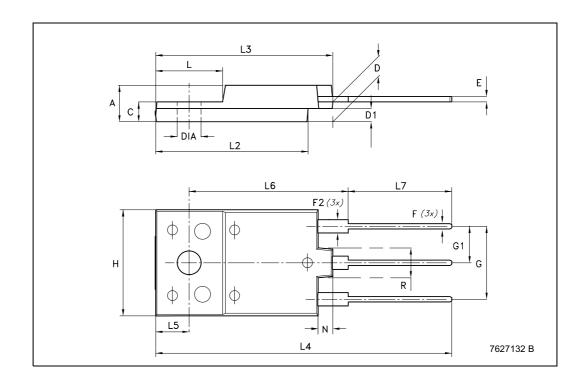
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## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

#### ISOWATT218FX MECHANICAL DATA

| DIM  |       | mm.   |       |  |  |
|------|-------|-------|-------|--|--|
| DIM. | MIN.  | TYP   | MAX.  |  |  |
| Α    | 5.30  |       | 5.70  |  |  |
| С    | 2.80  | 3.20  |       |  |  |
| D    | 3.10  |       | 3.50  |  |  |
| D1   | 1.80  |       | 2.20  |  |  |
| E    | 0.80  |       | 1.10  |  |  |
| F    | 0.65  |       | 0.95  |  |  |
| F2   | 1.80  |       | 2.20  |  |  |
| G    | 10.30 |       | 11.50 |  |  |
| G1   |       | 5.45  |       |  |  |
| Н    | 15.30 |       | 15.70 |  |  |
| L    | 9     |       | 10.20 |  |  |
| L2   | 22.80 | 23.20 |       |  |  |
| L3   | 26.30 | 26.70 |       |  |  |
| L4   | 43.20 | 44.40 |       |  |  |
| L5   | 4.30  | 4.70  |       |  |  |
| L6   | 24.30 | 24.70 |       |  |  |
| L7   | 14.60 |       | 15    |  |  |
| N    | 1.80  |       | 2.20  |  |  |
| R    | 3.80  |       | 4.20  |  |  |
| Dia  | 3.40  |       | 3.80  |  |  |



MD2009DFX Revision history

# 5 Revision history

Table 4. Revision history

| Date        | Revision | Changes                               |
|-------------|----------|---------------------------------------|
| 27-Feb-2006 | 1        | First release                         |
| 28-Mar-2006 | 2        | New curves 9 and 10 inserted          |
| 22-May-2006 | 3        | Values changed on Table 1 and Table 3 |

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